



Ø b 3 PLCS

⊕	Ø .50 (M) A B (M) C
	Ø .25 (M) A

VIEW A - A

THIS REGISTERED OUTLINE HAS BEEN PREPARED BY THE JEDEC JC-11 COMMITTEE, AND REFLECTS A PRODUCT WITH ANTICIPATED USAGE IN THE ELECTRONICS INDUSTRY, CHANGES ARE LIKELY TO OCCUR.

JEDEC SOLID STATE PRODUCT OUTLINE	TITLE: R-MSFM-X3 HERMETIC FLANGE MOUNTED HEADER FAMILY (PERIPHERAL TERMINALS) THREE LEAD, 5.0 SPACING	ISSUE: A	DATE: 9-94	ITEM TO-267	PAGE 1 OF 2
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S Y M B O L	--VARIATIONS				
	AA			NOTE	
	MIN	NOM	MAX		
A	6.60	7.00	7.40		
A1	1.25	1.50	1.80		
A2	4.00 BSC.				
Øb	1.40	1.50	1.65		
D	23.60	23.90	24.15		
D1	16.40	16.65	16.90		
D2	0.00	0.00	2.35		
e	5.0 BSC.				
E	20.20	20.30	20.45		
L	12.70	15.90	19.05		
L1	19.80	20.20	20.60		
ØP	3.95	4.05	4.20		
NOTE	1, 2, 3,				
REF	ITEM 10-349				
ISSUE	A				
NOTES:					
1. REFER TO APPLICABLE SYMBOL LIST.					
2. DIMENSIONS AND TOLERANCING PER ANSI Y14.5.M. 1982.					
3. CONTROLLING DIMENSION: MILLIMETERS.					
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